

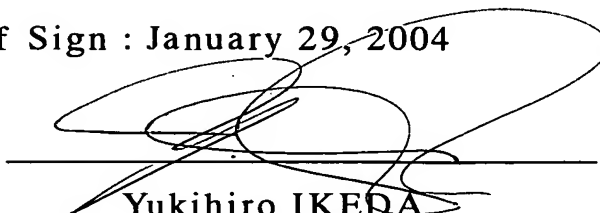
Declaration

I, Yukihiro IKEDA, a national of Japan, c/o Asamura Patent Office of 331-340, New Ohtemachi Building, 2-1, Ohtemachi-2-chome, Chiyoda-ku, Tokyo, Japan do hereby solemnly and sincerely declare:-

- 1) THAT I am well acquainted with the Japanese language and English language, and
- 2) THAT the attached is a full, true, accurate and faithful translation into the English language made by me of Japanese Text of the U.S. Serial No. 10/722450 filed on November 28, 2003.

The undersigned declares further that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001, of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date of Sign : January 29, 2004



Yukihiro IKEDA
Patent Attorney

- 1 -

THERMOPLASTIC RESIN COMPOSITION AND MOLDINGS
OF THE SAME

CROSS-REFERENCE TO RELATED APPLICATION

This application is a continuation-in-part of our co-pending application, serial No. (not yet assigned), filed on November 21, 2003, based on
5 PCT/JP02/04913, the content of which is incorporated herein by reference.

BACKGROUND OF THE INVENTION

(1) Field of the Invention

The present invention relates to a resin
10 composition markedly improved, particularly, in tensile elongation and multi-axial impact strength as well as Izod impact strength while retaining flowability and heat resistance, and further relates to injection moldings made from the resin composition.

15 (2) Description of the Related Art

A polyphenylene ether has been extensively used because of superiority in its mechanical properties, electrical properties and heat resistance and further superiority in its dimensional stability.
20 However, polyphenylene ether has a serious defect that it is inferior in oil resistance and molding processability when used singly. In order to dissolve

the defect, JP-B-45-997 proposes a technique, wherein a polyamide is blended with polyphenylene ether. At present, such a material has come to be extensively used for various applications.

5 A technique of adding an impact improving material to a polymer alloy comprising a polyphenylene ether and a polyamide in order to impart impact resistance is disclosed in USP 4,315,086. Examples of the impact improving material disclosed therein include
10 di-block copolymers or tri-block copolymers of ethylene propylene rubber, SBR, polybutadiene or polystyrene-diene rubber or partial hydrides thereof.

 JP-A-2-58563 discloses a technique, wherein two kinds of elastomers, namely, an ABA type tri-block
15 copolymer and an AB type di-block copolymer are blended with each other, to improve impact resistance.

 Further, JP-A-6-240130 discloses a technique, wherein two or more block copolymers having different weight ratios of an aromatic vinyl compound block are
20 blended, to improve molding processability, mechanical properties and heat resistance.

 In recent years, compositions comprising the polyamide/polyphenylene ether alloy have been used for the applications, such as a relay block, which is one
25 of the car electrical device parts, or for doors and fenders which are exterior trim parts of cars. In these applications, it is required to particularly enhance multi-axial impact strength, such as falling

weight impact strength, among impact strengths. The improvement of the multi-axial impact strength is extremely difficult because this must be achieved while substantially retaining other important properties such
5 as flowability and heat resistance.

WO 02/094936 discloses a technique wherein deterioration of surface appearance and generation of black spots at the time of production can be inhibited while retaining Izod impact strength after heat
10 exposure by using more than one block copolymers different in molecular weight.

Hitherto, impact strength has generally been evaluated by the method called shock fracture toughness, such as (notched) Izod impact test. This is
15 an impact test under mechanical conditions which are severe for materials or articles, and the resulting values do not necessarily show the practical impact strength of the materials or articles. Rather, as described in "Impact Resistance of Plastics" (written
20 by Ikuo Narusawa, published from Sigma Publishing Co., p.1-4), tensile tests or multi-axial impact tests which measure responses with reflecting as much as possible the properties of materials without notching are often regarded to correspond well to the practical impact
25 strength.

According to the above-mentioned conventional techniques, these problems cannot sufficiently be solved. With the expansion of applications, it has

been desired to improve impact strength, corresponding to car crash or falling of containers, particularly, multi-axial impact strength, while maintaining flowability and heat resistance.

5 The object of the present invention is to provide a thermoplastic resin composition improved in impact characteristics corresponding to car crash or falling of containers, particularly, tensile elongation and multi-axial impact strength, while maintaining
10 flowability and heat resistance of polyamide/polyphenylene ether alloys, and further to provide moldings made from the composition.

SUMMARY OF THE INVENTION

 As a result of intensive research conducted
15 by the inventors in an attempt to solve the above problems, it has been found that a thermoplastic resin composition remarkably improved in toughness, particularly, tensile elongation and multi-axial impact strength, while maintaining flowability and heat
20 resistance and furthermore moldings of the said composition can be obtained when two or more block copolymers are used in combination and the number-average molecular weight of one polymer block mainly composed of an aromatic vinyl compound and that of one
25 polymer block mainly composed of a conjugated diene compound are set within optimum ranges.

 That is, the present invention relates to a

thermoplastic resin composition comprising:

(A) 50 to 90 parts by weight of a polyamide,

(B) 50 to 10 parts by weight of a
polyphenylene ether, and

5 (C) 1 to 35 parts by weight of a block
copolymer comprising at least one polymer block mainly
composed of an aromatic vinyl compound and at least one
polymer block mainly composed of a conjugated diene
compound, and/or the block copolymer which is

10 hydrogenated, wherein the weight is based on 100 parts
by weight of the sum of (A) and (B),

characterized in that the component (C) is a
mixture of two or more block copolymers comprising (C1)
a block copolymer containing a polymer block mainly
15 composed of an aromatic vinyl compound in an amount of
55% by weight or more but less than 90% by weight and
(C2) a block copolymer containing a polymer block
mainly composed of an aromatic vinyl compound in an
amount of 20% by weight or more but less than 55% by
20 weight, and one of the polymer block mainly composed of
an aromatic vinyl compound in the mixture has a number
average molecular weight of 10,000 or more but less
than 30,000 and one of the polymer block mainly
composed of a conjugated diene compound in the mixture
25 has a number average molecular weight of 50,000 or more
and less than 100,000. The present invention further
relates to moldings of the above thermoplastic resin
composition.

The thermoplastic resin composition and moldings comprising the thermoplastic resin composition can be improved in impact characteristics against car crash of, such as tensile elongation and multi-axial impact strength, while maintaining flowability and heat resistance.

PREFERRED EMBODIMENTS OF THE INVENTION

Respective components that can be used in the present invention are described in detail hereinbelow.

10 The polyamide resin used in the present invention as the component (A) includes a polycondensate of a dibasic acid and a diamine, a ring opening polymerization product of a cyclic lactam, a polycondensate of an aminocarboxylic acid, and a
15 copolymer and a blend of thereof. More specifically, aliphatic polyamide resins such as polyamide 66, polyamide 46, polyamide 612, polyamide 610, polyamide 6, polyamide 11 and polyamide 12; aliphatic and aromatic polyamide resins such as poly-m-
20 xyleneadipamide (polyamide MXD6), polyhexamethyleneterephthalamide (polyamide 6T), and polyhexamethyleneisophthalamide (polyamide 6I); and copolymers or blends thereof may be used. In the present invention, polyamide 66, polyamide 6, polyamide
25 66/6 and polyamide 66/6I are especially preferred because they are superior in heat resistance and mechanical strength. Most preferred are polyamide 66,

polyamide 6 and a mixture thereof.

The polymerization degree of the polyamide resin (A) used in the present invention is not particularly limited, but from the point of usual
5 injection molding processability, the relative viscosity is preferably 2.0 or more, more preferably 2.2-3.0, as determined at 25°C in a 98% sulfuric acid solution in accordance with JIS K6810. The polyamide resin (A) used in the present invention is not limited
10 to these polyamide resins and may be a mixture of more than one polyamide resins having different molecular weights.

The polymerization method for the polyamide resins used in the present invention is not
15 particularly limited, but can be any of melt polymerization, interfacial polymerization, solution polymerization, bulk polymerization, solid polymerization and combination of these polymerization methods. Among them, melt polymerization is more
20 preferred.

The terminal groups of the polyamide participate in the reaction with a functional polyphenylene ether. Usually, the polyamide resin has an amino group and a carboxyl group as the terminal
25 groups. Generally speaking, an increase of carboxyl group concentration lowers impact resistance but raises flowability, while an increase of amino group concentration raises impact resistance but lowers

flowability.

In the present invention, a ratio of such terminal groups in terms of amino group/carboxyl group concentration ratio is preferably from 9/1 to 1/9, more
5 preferably from 8/2 to 1/9, further preferably from 6/4 to 1/9.

The concentration of the carboxyl group is preferably higher by at least 30 milli-equivalent/kg than the concentration of the amino group. Moreover,
10 the concentration of the terminal amino group is preferably at least 10 milli-equivalent/kg, and more preferably 30 milli-equivalent/kg or more.

Such terminal groups of the polyamide resin can be controlled in a known manner obvious to a person
15 skilled in the art. For example, a technique wherein diamines, dicarboxylic acids, monocarboxylic acids, etc. are added at the time of the polymerization of the polyamide resin so as to obtain a pre-determined terminal group concentration.

20 In the present invention, a metal stabilizer, which is known to be used for improving heat stability of the polyamide resin, such as those described in JP-A-1-163262, can be used without any problem.

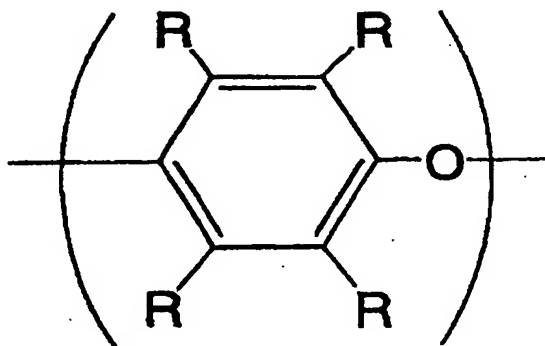
Particularly preferable examples of the metal
25 stabilizer include CuI, CuCl₂, copper acetate, cerium stearate, and the like. In addition, alkyl metal halides, such as potassium iodide, potassium bromide and the like, can also be suitably used. Naturally, it

is permitted that more than one stabilizers are used at the same time.

The metal stabilizer and/or the alkyl metal halide may be added in a total amount of preferably
5 from 0.001 to 1 part by weight with respect to 100 parts by weight of the polyamide resin.

Furthermore, known additives which can be added to the polyamide may be added in an amount of less than 10 parts by weight with respect to 100 parts
10 by weight of the polyamide.

The polyphenylene ether (B) that can be used in the present invention is a homopolymer and/or a copolymer comprising a structural unit of the following formula (1),



[wherein O represents an oxygen atom, and each R independently represents hydrogen, halogen, primary or secondary lower alkyl, phenyl, haloalkyl, aminoalkyl, hydrocarbyloxy or halohydrocarbyloxy in which the
15 halogen atom and the oxygen atom are separated from each other by at least two carbon atoms].

Specific examples of the polyphenylene ether (B) in the present invention include poly(2,6-dimethyl-1,4-phenylene ether), poly(2-methyl-6-ethyl-1,4-phenylene ether), poly(2-methyl-6-phenyl-1,4-phenylene ether), poly(2,6-dichloro-1,4-phenylene ether), etc. In addition, polyphenylene ether copolymers, such as a copolymer of 2,6-dimethylphenol and another phenol (for example, a copolymer of 2,6-dimethylphenol and 2,3,6-trimethylphenol, and a copolymer of 2,6-dimethylphenol and 2-methyl-6-butylphenol, as described in JP-B-52-17880).

Among these, particularly preferred polyphenylene ethers include poly(2,6-dimethyl-1,4-phenylene ether), a copolymer of 2,6-dimethylphenol and 2,3,6-trimethylphenol and a mixture thereof.

As to the ratio of respective monomer units in the case of using a copolymer of 2,6-dimethylphenol and 2,3,6-trimethylphenol as the polyphenylene ether, an especially preferable copolymer is a copolymer comprising about 80 to about 90 weight % of 2,6-dimethylphenol and about 10 to about 20 weight % of 2,3,6-trimethylphenol when the total amount of the polyphenylene ether is assumed to be 100 weight %.

A method for producing the polyphenylene ether (B) used in the present invention is not particularly limited as far as it is already known. For example, the production processes described in U.S. Patent Nos. 3,306,874; 3,306,875; 3,257,357 and

3,257,358; JP-A-50-51197 and JP-A-63-152628 are included.

The polyphenylene ether (B) that can be used in the present invention has a reduced viscosity (η sp/c: measured in a 0.5 g/dl chloroform solution at 30°C) ranging preferably from 0.15 to 0.70 dl/g, more preferably from 0.20 to 0.60 dl/g, and further more preferably from 0.40 to 0.55 dl/g.

In the present invention, a mixture of two or more polyphenylene ethers having different reduced viscosity can be used without any problem. Examples thereof include, but are not limited to, a mixture of a polyphenylene ether having a reduced viscosity of 0.45 dl/g or less and a polyphenylene ether having a reduced viscosity of 0.50 dl/g or more, and a mixture of a low molecular weight polyphenylene ether having a reduced viscosity of 0.40 dl/g or less and a polyphenylene ether having a reduced viscosity of 0.50 dl/g or more.

Further, it is permitted that the polyphenylene ether (B) that can be used in the present invention is a polyphenylene ether modified in its entirety or in part.

The modified polyphenylene ether referred to herein is a polyphenylene ether modified with at least one modifying compound having at least one carbon-carbon double or triple bond and at least one carboxylic acid group, acid anhydride group, amino group, hydroxyl group or glycidyl group in its

molecular structure.

The processes for producing the modified polyphenylene ether include, for example, (1) a process comprising reacting a polyphenylene ether with a
5 modifying compound in the presence or absence of a radical initiator at a temperature of 100°C or more but lower than the glass transition temperature of the polyphenylene ether while keeping the polyphenylene ether non-melted, (2) a process comprising melt-
10 kneading a polyphenylene ether and a modifying compound in the presence or absence of a radical initiator, at a temperature in the range from the glass transition temperature of the polyphenylene ether to 360°C, and
(3) a process comprising reacting a polyphenylene ether
15 with a modifying compound in a solution in the presence or absence of a radical initiator at a temperature lower than the glass transition temperature of the polyphenylene ether. Of these processes, the processes (1) and (2) are preferred.

20 Next, at least one modifying compound having at least one carbon-carbon double or triple bond and at least one carboxylic acid group, acid anhydride group, amino group, hydroxyl group or glycidyl group in its molecular structure is described in detail as follows.

25 Examples of the modifying compound having a carbon-carbon double and a carboxylic acid group or an acid anhydride group in the molecule at the same time include maleic acid, fumaric acid, chloromaleic acid,

cis-4-cyclohexene-1,2-dicarboxylic acid and their acid anhydrides. Of these, preferred are fumaric acid, maleic acid and maleic anhydride, and particularly preferred are fumaric acid and maleic anhydride.

5 Further, it is possible to use a compound wherein one or two carboxylic acid group(s) in these unsaturated dicarboxylic acids is(are) formed into an ester(s).

10 Examples of the modifying compound having a carbon-carbon double bond and a glycidyl group in the molecule at the same time include allyl glycidyl ether, glycidyl acrylate, glycidyl methacrylate and epoxydized natural fats and oils.

15 Of these, particularly preferred are glycidyl acrylate and glycidyl methacrylate.

20 Examples of the modifying compound having a carbon-carbon double bond and a hydroxyl group in the molecule at the same time include unsaturated alcohols of the general formula, $C_nH_{2n-3}OH$ (n is a positive integer), such as allyl alcohol, 4-penten-1-ol and 1,4-pentadien-3-ol, and other unsaturated alcohols of the general formula, $C_nH_{2n-5}OH$ or $C_nH_{2n-7}OH$ (n is a positive integer).

25 The above-mentioned modifying compounds may be used singly or in combination of two or more thereof.

 In the production of the modified polyphenylene ether, the modifying compound is added in

an amount of preferably from 0.1 to 10 parts by weight, and more preferably from 0.3 to 5 parts by weight, with respect to 100 parts by weight of the polyphenylene ether.

5 In the production of the modified polyphenylene ether in the presence of a radical initiator, the radical initiator is used in an amount of preferably from 0.001 to 1 part by weight with respect to 100 parts by weight of the polyphenylene
10 ether.

The addition rate of the modifying compound in the modified polyphenylene ether is preferably from 0.01 to 5 weight %, and more preferably from 0.1 to 3 weight %.

15 It is permitted that an unreacted modifying compound and/or a polymer of the modifying compound remain(s) in the modified polyphenylene ether.

Further, if desired, it is permitted that a compound having an amide bond and/or an amino group is
20 added at the time of production of the modified polyphenylene ether in order to decrease the amount of the residual modifying compound and/or the polymer of the modifying compound in the modified polyphenylene ether.

25 The compound having an amide bond referred to herein is a compound having an amide bond $\{-\text{NH}-\text{C}(=\text{O})-\}$ in its molecular structure. The compound having an amino group is a compound having an amino group $\{-\text{NH}_2\}$

at its terminal. Specific examples of these compounds include, but are not limited to, aliphatic amines, such as octylamine, nonylamine, tetramethylenediamine and hexamethylenediamine; aromatic amines, such as aniline, 5 m-phenylenediamine, p-phenylenediamine, m-xylylenediamine and p-xylylenediamine; reaction products between the above-mentioned amines and carboxylic acids, dicarboxylic acids or the like; lactams, such as ϵ -caprolactam; and polyamide resins.

10 These compounds having an amide bond or an amino group, if added, are used in an amount of preferably 0.001 part by weight or more but less than 5 parts by weight, more preferably 0.01 part by weight or more but less than 1 part by weight, and further more 15 preferably 0.01 part by weight or more but less than 0.1 part by weight, with respect to 100 parts by weight of the polyphenylene ether.

 In addition, in the present invention, it is permitted to add a styrenic thermoplastic resin, 20 provided that the amount thereof is less than 50 parts by weight with respect to 100 parts by weight of the sum of the polyamide (A) and the polyphenylene ether (B).

 Examples of the styrenic thermoplastic resin 25 referred to in the present invention include styrene homopolymer, rubber modified polystyrene (HIPS), styrene-acrylonitrile copolymers (AS resin) and styrene-rubbery polymer-acrylonitrile copolymers (ABS

resin), etc.

Furthermore, it is permitted that known additives safely added to the polyphenylene ether are added, provided that the amount thereof is less than 10 parts by weight with respect to 100 parts by weight of the polyphenylene ether.

Next, the block copolymer (C) that can be used in the present invention is described in detail.

The block copolymer (C) that can be used in the present invention is a block copolymer comprising at least one polymer block mainly composed of an aromatic vinyl compound and at least one polymer block mainly composed of a conjugated diene compound.

Specific examples of the aromatic vinyl compound include styrene, α -methylstyrene and vinyltoluene, etc. At least one compound selected therefrom is used. Of these, particularly preferred is styrene.

Specific examples of the conjugated diene compound include butadiene, isoprene, piperylene and 1,3-pentadiene, etc. At least one compound selected therefrom is used. Of these, preferred are butadiene, isoprene and a combination thereof.

When butadiene is used as the conjugated diene for the block copolymer, it is preferred that a 1,2-vinyl content or a total content of a 1,2-vinyl content and a 3,4-vinyl content in the micro structure of the polybutadiene block portion is from 5 to 80%,

more preferably from 10 to 50%, and much more preferably from 15 to 40%.

As the block copolymer in the present invention, it is preferred that the block copolymer has
5 a bonding type selected from a-b, a-b-a and a-b-a-b types, wherein (a) is the polymer block mainly composed of the aromatic vinyl compound and (b) is the polymer block mainly composed of the conjugated diene compound.

Among these, more preferred is a-b-a type.

10 It is permitted that it is a combination of these bonding types.

Further, it is more preferred that the block copolymer of the aromatic vinyl compound and the conjugated diene compound that can be used in the
15 present invention is a hydrogenated block copolymer. The hydrogenated block copolymer is obtained by hydrogenating the block copolymer of the aromatic vinyl compound and the conjugated diene compound, so that the percentage of aliphatic double bonds in the polymer
20 block mainly composed of the conjugated diene is controlled to be within a range of from more than 0 to 100%. The hydrogenation rate in the hydrogenated block copolymer is preferably 50% or more, more preferably 80% or more, and the most preferably 98% or more.

25 The block copolymer used may be a mixture of the non-hydrogenated block copolymer and the hydrogenated block copolymer.

In the present invention, it is necessary

that the block copolymer of the component (C) is a mixture of two or more block copolymers comprising (C1) a block copolymer containing a polymer block mainly composed of an aromatic vinyl compound in an amount of
5 55 weight % or more but less than 90 weight % and (C2) a block copolymer containing a polymer block mainly composed of an aromatic vinyl compound in an amount of 20 weight % or more but less than 55 weight %.

Furthermore, it is necessary that one of the
10 polymer block mainly composed of an aromatic vinyl compound in the mixture has a number average molecular weight of 10,000 or more but less than 30,000 and one of the polymer block mainly composed of a conjugated diene compound in the mixture has a number average
15 molecular weight of 50,000 or more but less than 100,000. It is more preferred that one of the polymer block mainly composed of an aromatic vinyl compound in the mixture of the block copolymers has a number average molecular weight of 10,000 or more but less
20 than 25,000 and one of the polymer block mainly composed of a conjugated diene compound in the mixture has a number average molecular weight of 50,000 or more but less than 80,000.

The term "mainly composed of" in the polymer
25 block mainly composed of an aromatic vinyl compound of the present invention means that at least 50 weight % of the block is the aromatic vinyl compound. The content of the aromatic vinyl compound thereof is more

preferably 70 weight % or more, more preferably 80 weight % or more, and most preferably 90 weight % or more. The same applies to the term "mainly composed of" in the polymer block mainly composed of a
5 conjugated diene compound, and the term means that at least 50 weight % of the block is the conjugated diene compound. The content of the conjugated diene compound thereof is more preferably 70 weight % or more, more preferably 80 weight % or more, and most preferably 90
10 weight % or more.

Even in the case where the block is, for example, an aromatic vinyl compound block to which a small amount of the conjugated diene compound or other compound is randomly bonded, as long as the aromatic
15 vinyl compound comprises 50 weight % of the block, this is regarded to be a block copolymer mainly composed of an aromatic vinyl compound. The same applies to the block copolymer mainly composed of a conjugated diene compound.

20 In order to develop the effect of the invention to remarkably improve toughness, particularly, tensile elongation and multi-axial impact strength while retaining flowability and heat resistance, it is important that the number average
25 molecular weight of one polymer block mainly composed of the aromatic vinyl compound in the mixture of two or more block copolymers comprising the component (C1) and the component (C2) and the number average molecular

weight of one polymer block mainly composed of the conjugated diene compound in the mixture are adjusted to the above-mentioned ranges.

The number average molecular weight of one
5 polymer block mainly composed of the aromatic vinyl compound in the block copolymers and the number average molecular weight of one polymer block mainly composed of the conjugated diene compound in the mixture can be calculated from the number average molecular weights of
10 the respective block copolymers of the component (C) and weight % of all the polymer blocks mainly composed of the aromatic vinyl compound in the block copolymers and weight % of all the polymer blocks mainly composed of the conjugated diene compound in the block
15 copolymers.

Specifically, the number average molecular weights of the respective block copolymers of the component (C) referred to in the present invention are obtained by a gel permeation chromatography measurement
20 apparatus (GPC SYSTEM 21, manufactured by Showa Denko K.K.) with an ultraviolet spectral detector (UV-41, manufactured by Showa Denko K.K.) and converting the measurement based on the polystyrene standard.

[solvent: chloroform; temperature: 40°C; column: sample
25 side (K-G, K-800RL, K-800R), reference side (K-805L x 2); flow: 10 ml/min; measurement wavelength: 254 nm; pressure: 15 to 17 kg/cm²]. In the measurement, a low molecular weight component owing to catalyst

deactivation in the course of polymerization may be detected. In such a case, the low molecular weight component is not incorporated in the molecular weight calculation.

5 The number average molecular weight of a block copolymer contained in the composition can be obtained, for example, in the following manner. A pellet is sliced to a thickness of 20 to 50 μm by a microtome, and the slices are dipped in chloroform and
10 subjected to extraction for about 1 hour using a thermostatic shaking machine set at about 80°C to dissolve polyphenylene ether and the block copolymer in chloroform. The solution is subjected to filtration and methanol is dripped into the filtrate in an amount
15 of three times the amount of the filtrate to cause reprecipitation, followed by vacuum drying. The resulting powdery sample is further dissolved in methylene chloride, and the solution is left to stand for 12 hours in an environment of -10°C . The
20 precipitated component (polyphenylene ether component) is filtered off, and the filtrate is subjected to measurement by the gel permeation chromatography measurement apparatus to determine the number average molecular weight.

25 The number average molecular weight of the polymer block mainly composed of the aromatic vinyl compound in one kind of the block copolymer can be obtained by the following equation using the above-

mentioned number average molecular weight of the block copolymer,

$$Mn_{(a),n} = \{Mn \times a / (a + b)\} / N_{(a)} \quad (1)$$

wherein $Mn_{(a),n}$ is the number average molecular weight of one polymer block mainly composed of the aromatic vinyl compound in the block copolymer n, Mn is the number
5 average molecular weight of the block copolymer n, a is the weight % of the polymer block mainly composed of the aromatic vinyl compound in the block copolymer n, b is the weight % of the polymer block mainly composed of
10 the conjugated diene compound in the block copolymer n, and $N_{(a)}$ is the number of the polymer block mainly composed of the aromatic vinyl compound in the block copolymer n.

Furthermore, since the block copolymer of the
15 component (C) is a mixture of two or more block copolymers comprising the component (C1) and the component (C2), the number average molecular weight of one polymer block mainly composed of the aromatic vinyl compound in the mixture can be obtained by the
20 following equation,

$$Mn_{(a),av} = \Sigma (Mn_{(a),n} \times Cn) \quad (2)$$

wherein $Mn_{(a),av}$ is the number average molecular weight of one polymer block mainly composed of the aromatic vinyl

compound in the mixture of the block copolymers, $Mn_{(a),n}$ is the number average molecular weight of one polymer block mainly composed of the aromatic vinyl compound of the block copolymer n, C_n is a weight fraction of the
5 block copolymer n in the mixture of the block copolymers. On the other hand, the number average molecular weight of one polymer block mainly composed of the conjugated diene compound in one kind of the block copolymer can be obtained by the following
10 equation using the above-mentioned number average molecular weight of the block copolymer,

$$Mn_{(b),n} = \{Mn \times b / (a + b)\} / N_{(b)} \quad (3)$$

wherein $Mn_{(b),n}$ is the number average molecular weight of one polymer block mainly composed of the conjugated diene compound in the block copolymer n, Mn is the
15 number average molecular weight of the block copolymer n, a is the weight % of the polymer block mainly composed of the aromatic vinyl compound in the block copolymer n, b is the weight % of the polymer block mainly composed of the conjugated diene compound in the
20 block copolymer n, and $N_{(b)}$ is the number of the polymer block mainly composed of the conjugated diene compound in the block copolymer n.

Furthermore, since the block copolymer of the component (C) is a mixture of two or more block
25 copolymers comprising the component (C1) and the

component (C2), the number average molecular weight of one polymer block mainly composed of the conjugated diene compound in the mixture can be obtained by the following equation,

$$Mn_{(b),av} = \sum (Mn_{(b),n} \times Cn) \quad (4)$$

5 wherein $Mn_{(b),av}$ is the number average molecular weight of one polymer block mainly composed of the conjugated diene compound in the mixture of the block copolymers, $Mn_{(b),n}$ is the number average molecular weight of one polymer block mainly composed of the conjugated diene
10 compound of the block copolymer n, Cn is a weight fraction of the block copolymer n in the mixture of the block copolymers.

Moreover, when the component (C) in the present invention is a mixture composed of block
15 copolymers having a number average molecular weight of less than 120,000, decrease in flowability can be inhibited, and hence such component (C) is more preferred.

In the present invention, it is more
20 preferred that the molar ratio of the component (C1) and the component (C2), $N_{(C1)}/N_{(C2)}$, is in the range of 0.2 to 1.0. Further preferably, the molar ratio is in the range of 0.2 to 0.6.

When the molar ratio of the component (C1)
25 and the component (C2), $N_{(C1)}/N_{(C2)}$, is 0.2 or more,

decrease in heat distortion resistance under high load can be inhibited. Further, when the molar ratio $N_{(C1)}/N_{(C2)}$ is 1.0 or less, impact strength can be kept high.

- 5 The molar ratio of the component (C1) and the component (C2), $N_{(C1)}/N_{(C2)}$, can be obtained by the following equation using the number average molecular weight of each block copolymer,

$$N_{(C1)}/N_{(C2)} = \Sigma (C1_{(n)}/Mn_{(C1,n)}) / \Sigma (C2_{(n)}/Mn_{(C2,n)})$$

- 10 wherein $Mn_{(C1,n)}$ is the number average molecular weight of the block copolymer n of the component C1, $Mn_{(C2,n)}$ is the number average molecular weight of the block copolymer n of the component C2, $C1_{(n)}$ is a weight fraction of the block copolymer n of the component C1, and $C2_{(n)}$ is a
15 weight fraction of the block copolymer n of the component C2.

- With respect to these aromatic vinyl compound-conjugated diene compound block copolymers, it is permitted to use a mixture of those different from
20 one another in the bonding type, the species of the aromatic vinyl compound, the species of the conjugated diene compound, the 1,2-bond vinyl content, the total of 1,2-bond vinyl content and 3,4-bond vinyl content, the content of the aromatic vinyl compound component or
25 the hydrogenation rate, as long as it is not contrary to the object of the present invention.

Further, it is permitted that the block copolymer used in the present invention is a block copolymer modified in its entirety or in part.

The modified block copolymer referred to
5 herein is a block copolymer modified with at least one modifying compound, having at least one carbon-carbon double or triple bond and at least one carboxylic acid group, acid anhydride group, amino group, hydroxyl group or glycidyl group in its molecular structure.

10 Examples of a process for producing the modified block copolymer include (1) a process comprising melt-kneading a block copolymer and a modifying compound in the presence or the absence of a radical initiator, at a temperature in the range from
15 the softening point of the block copolymer to 250°C, (2) a process comprising reacting a block copolymer and a modifying compound in a solution in the presence or the absence of a radical initiator at a temperature of the softening point of the block copolymer or lower,
20 and (3) a process comprising carrying out reaction between a block copolymer and a modifying compound in the presence or the absence of a radical initiator at a temperature of the softening point of the block copolymer or lower while keeping both non-melted.
25 Although any of these processes may be used, preferred is the process (1), and the most preferred is the process (1) wherein the reaction is carried out in the presence of a radical initiator.

With respect to the at least one modifying compound having at least one carbon-carbon double or triple bond and at least one carboxylic acid group, acid anhydride group, amino group, hydroxyl group or
5 glycidyl group in its molecular structure, those described hereinabove in connection with the modified polyphenylene ether can be used.

It is permitted that an oil comprising paraffin as the main component is incorporated into the
10 block copolymer in accordance with the present invention in advance. When the oil comprising paraffin as the main component is incorporated in advance, the processability of the resin composition can be improved.

15 In this case, the oil comprising paraffin as the main component is incorporated in an amount of preferably from 1 to 70 parts by weight with respect to 100 parts by weight of the block copolymer. If the oil is incorporated in an amount of more than 70 parts by
20 weight, the resin composition is inferior in handleability.

The oil comprising paraffin as the main component referred to herein is a mixture of, hydrocarbon compounds having a weight average molecular
25 weight of from 500 to 10,000, which is, a combination of three, i.e. an aromatic ring-bearing compound, a naphthene ring-bearing compound and a paraffinic compound, wherein the content of the paraffinic

compound is 50 weight % or more.

A more preferred oil comprising paraffin as the main component is the one composed of 50 to 90 weight % of a paraffinic compound, 10 to 40 weight % of
5 a naphthene ring-bearing compound and 5 weight % or less of an aromatic ring-bearing compound.

Such an oil comprising paraffin as the main component is commercially available. Examples thereof include PW380 manufactured by Idemitsu Kosan Co., Ltd.
10 and so on.

Further, in the present invention, it is permitted to add a conductive material as a component (D).

The conductive material usable in the present
15 invention is preferably non-metallic one such as carbon used for the purpose of imparting conductivity to a non-conductive material.

Examples of the carbon include Ketjen black (EC, EC-600JD) available from Ketjen Black
20 International Co., Ltd. and carbon fibril (BN fibril) available from Hyperion Catalysis International Co., Ltd. Especially preferred is the carbon fibril disclosed in W094/23433.

The amount of the conductive material is
25 preferably 0.1 part by weight or more but less than 3 parts by weight, more preferably 0.5 part by weight or more but less than 2.5 parts by weight with respect to 100 parts by weight of the sum of the components (A) to

(C). If the amount of the conductive material is 3 parts by weight or more, impact resistance and flowability of the thermoplastic resin composition may be deteriorated.

5 The method of blending the conductive material is not particularly limited, but include, for example, a method of adding the powdery conductive material as it is together with polyphenylene ether, a method of adding the powdery conductive material as it
10 is together with polyamide, and a method of adding the powdery conductive material as it is after the polyamide and the polyphenylene ether are compatibilized as described in U.S. Patent Nos. 5741846 and 5977240.

15 Furthermore, the conductive material may be added in the form of a master batch comprising an elastomer or polyphenylene ether in which the conductive material is incorporated as disclosed in Examples of WO01/81473 or may be added as a master
20 batch comprising a polyamide in which carbon black is previously uniformly dispersed as disclosed in JP-A-2-201811 or as a carbon fibril master batch such as a polyamide 66/carbon fibril master batch available from Hyperion Catalyst International Co., Ltd. (trade name:
25 Polyamide 66 with FibrilTM Nanotubes RMB4620-00: carbon fibril content 20%).

Further, in the present invention, it is preferred to add a known compatibilizer during the

production of the composition.

The main purpose of using a compatibilizer is to improve the physical properties of the polyamide-polyphenylene ether mixture. The compatibilizer that
5 can be used in the present invention is a polyfunctional compound interactive with the polyphenylene ether, the polyamide or both of them. The interaction may be not only chemical (for example, graft formation) but also physical (for example,
10 alteration of the surface characteristics of a dispersed phase).

In any case, the resulting polyamide-polyphenylene ether mixture can exhibit improved compatibility.

15 Examples of the compatibilizer that can be used in the present invention are described in, for example, WO01/81473, and all of these known compatibilizers can be used alone or in combination.

Among these various compatibilizers, examples
20 of particularly preferred compatibilizers include maleic acid, maleic anhydride and citric acid.

The compatibilizer in the present invention is used in an amount of preferably from 0.01 to 10 parts by weight, more preferably from 0.1 to 5 parts by
25 weight, and most preferably from 0.1 to 1 part by weight with respect to 100 parts by weight of the polyamide-polyphenylene ether mixture.

In the present invention, it is permitted

that an additive component other than the components mentioned above is added as far as the effects of the components mentioned above are not impaired.

Examples of the additive components are shown
5 below.

They include other thermoplastic resins, such as polyesters and polyolefins; inorganic fillers (for example, talc, kaolin, xonotlite, wallastonite, titanium oxide, potassium titanate, carbon fiber and
10 glass fiber); silane coupling agents known and used for the purpose of increasing the compatibility of an inorganic filler and a resin; flame retardants (for example, halogenated resins, silicone flame retardants, magnesium hydroxide, aluminum hydroxide, organic
15 phosphoric acid ester compounds, ammonium polyphosphate and red phosphorus); fluorine based polymers exhibiting a drop prevention effect; plasticizers (for example, oils, low molecular weight polyolefins, polyethylene glycol and fatty acid esters); flame retarding
20 assistants, such as antimony trioxide; coloring agents, such as carbon black; antistatic agents; various peroxides; zinc oxide; zinc sulfide; antioxidants; ultraviolet absorbers and photo-stabilizers.

These additive components are added in a
25 total amount not exceeding 100 parts by weight with respect to 100 parts by weight of the sum of the components (A) to (C).

Specific examples of a processing machine

used for the production of the composition in accordance with the present invention include, for example, a single screw extruder, a twin screw extruder, a roll, a kneader, the Brabender Plastograph
5 and the Banbury mixer. Of these, a twin screw extruder is preferred, and particularly, the most preferred is a twin screw extruder equipped with an upstream feed opening and one or more downstream feed openings and having a screw diameter of 45 mm or more and an L/D of
10 30 or more.

By using a twin screw extruder having a screw diameter of 45 mm or more and an L/D of 30 or more, insufficient kneading can be avoided and desired physical properties (especially, impact strength and
15 tensile elongation) can be obtained.

More specifically, the production method in the present invention includes:

(1) a method wherein a block copolymer and a polyphenylene ether are fed from the upstream feed
20 opening and melt-kneaded, and thereafter a polyamide is fed from the downstream feed opening and melt-kneaded;

(2) a method wherein a part of a block copolymer and a polyphenylene ether are fed from the upstream feed opening and melt-kneaded, and thereafter
25 a polyamide and the remaining block copolymer are fed from the downstream feed opening and melt-kneaded; and

(3) a method wherein a polyphenylene ether is fed from the upstream feed opening and melt-kneaded,

and thereafter a block copolymer and a polyamide are fed from the downstream feed opening and melt-kneaded, using a twin screw extruder equipped with an upstream feed opening and one or more downstream feed openings.

- 5 Any of the methods mentioned above may be used.

It is desirable that when the screw length of the extruder is assumed to be 1.0, the downstream feed opening is provided at the position of 0.3-0.8 from the upstream side.

- 10 In this case, the melt-kneading temperature is not particularly limited. Usually, a condition at which a suitable composition is obtained can be optionally selected from a range of from 240 to 360°C, but a preferred temperature range is one within which
15 the polyphenylene ether is sufficiently melted and the block copolymer comprising the polymer block mainly composed of the aromatic vinyl compound and a polymer block mainly composed of the conjugated diene compound or the hydrogenated block copolymer is hardly
20 deteriorated with heat. This is specifically in the range of from 280 to 340°C. Especially, in the case of employing a method wherein a block copolymer and a material mainly composed of polyphenylene ether are fed from the upstream feed opening and melt-kneaded, and
25 thereafter a material mainly composed of polyamide is fed from the downstream feed opening and melt-kneaded, it is desired to set the temperature of the portion from the upstream feed opening to the downstream feed

opening at 300 to 340°C, and the temperature of the portion from the downstream feed opening to die at 280 to 300°C.

The thus obtained composition in accordance
5 with the present invention can be molded into molded products used for various parts according to a conventional molding method, such as injection-molding.

Examples of such various parts include motorbike or car electrical device parts, such as a
10 relay box material; electric and electronic parts, such as IC tray materials, chassis for various disk players and cabinets; OA parts and machinery parts, such as various computers and their peripheral devices; exterior parts, such as motorbike cowls and car
15 bumpers, fenders, door panels, various moldings, emblems, outer door handles, door mirror housings, wheel caps, roof rails and their staying materials and spoilers; and interior parts, such as instrument panels, console boxes and trim.

20 The present invention is described in more detail with reference to Examples and Comparative Examples as follows.

(Materials used)

Polyamide as the component (A):

Polyamide 6,6 resin (hereinafter referred to
25 as PA)

Relative viscosity (98% sulfuric acid/25°C) =
2.7 (JIS K6810)

Concentration of terminal amino group = 30
milli-equivalent/kg

5 Concentration of terminal carboxyl group =
100 milli-equivalent/kg

Polyphenylene ether as the component (B):

Reduced viscosity = 0.42 dl/g (hereinafter
referred to as PPE)

10 Block copolymer as the component (C):
(C1-1)

Structure: Polystyrene-hydrogenated
polybutadiene-polystyrene

Number average molecular weight = 58,000

15 Number average molecular weight per
polystyrene block = 19,400

Number average molecular weight of the
hydrogenated polybutadiene = 19,100

Total content of styrene component = 67%

20 1,2-Vinyl content = 41%

Hydrogenation rate of polybutadiene portion =
98% or more

(C1-2)

Structure: Polystyrene-hydrogenated
25 polybutadiene-polystyrene

Number average molecular weight = 77,000

Number average molecular weight per
polystyrene block = 25,800

Number average molecular weight of
5 hydrogenated polybutadiene = 25,400
Total content of styrene component = 67%
1,2-Vinyl content = 36%
Hydrogenation rate of polybutadiene portion =
98% or more

10 (C1-3)

Structure: Polystyrene-hydrogenated
polybutadiene-polystyrene

Number average molecular weight = 97,000
Number average molecular weight per
15 polystyrene block = 29,100
Number average molecular weight of
hydrogenated polybutadiene = 38,800
Total content of styrene component = 60%
1,2-Vinyl content = 36%
20 Hydrogenation rate of polybutadiene portion =
98% or more

(C1-4)

Structure: Polystyrene-hydrogenated
polybutadiene-polystyrene

25 Number average molecular weight = 115,000
Number average molecular weight per

polystyrene block = 34,500

Number average molecular weight of
hydrogenated polybutadiene = 46,000

Total content of styrene component = 60%

5 1,2-Vinyl content = 35%

Hydrogenation rate of polybutadiene portion =
98% or more

(C2-1)

Structure: Polystyrene-hydrogenated
10 polybutadiene-polystyrene

Number average molecular weight = 40,000

Number average molecular weight per
polystyrene block = 6,000

Number average molecular weight of
15 hydrogenated polybutadiene = 28,000

Total content of styrene component = 30%

1,2-Vinyl content = 29%

Hydrogenation rate of polybutadiene portion =
98% or more

20 (C2-2)

Structure: Polystyrene-hydrogenated
polybutadiene-polystyrene

Number average molecular weight = 55,000

Number average molecular weight per
25 polystyrene block = 8,000

Number average molecular weight of

hydrogenated polybutadiene = 39,000

Total content of styrene component = 29%

1,2-Vinyl content = 28%

Hydrogenation rate of polybutadiene portion =

5 98% or more

(C2-4)

Structure: Polystyrene-hydrogenated
polybutadiene-polystyrene

Number average molecular weight = 88,000

10 Number average molecular weight per
polystyrene block = 12,300

Number average molecular weight of
hydrogenated polybutadiene = 63,400

Total content of styrene component = 28%

15 1,2-Vinyl content = 32%

Hydrogenation rate of polybutadiene portion =
98% or more

(C2-5)

Structure: Polystyrene-hydrogenated
20 polyisoprene-polystyrene

Number average molecular weight = 100,000

Number average molecular weight per
polystyrene block = 15,000

Number average molecular weight of
25 hydrogenated polyisoprene = 70,000

Total content of styrene component = 30%

Hydrogenation rate of polyisoprene portion =
98% or more

(C2-6)

Structure: Polystyrene-hydrogenated
5 polyisoprene-polystyrene

Number average molecular weight = 170,000

Number average molecular weight per
polystyrene block = 25,500

Number average molecular weight of
10 hydrogenated polyisoprene = 119,000

Total content of styrene component = 30%

Hydrogenation rate of polyisoprene portion =
98% or more

(C2-7)

15 Structure: Polystyrene-hydrogenated
polybutadiene-polystyrene

Number average molecular weight = 170,000

Number average molecular weight per
polystyrene block = 29,800

20 Number average molecular weight of
hydrogenated polyisoprene = 110,500

Total content of styrene component = 35%

1,2-Vinyl content = 38%

Hydrogenation rate of polybutadiene portion =
25 98% or more

Paraffinic oil was contained in an amount of

35 weight % or more.

(C2-8)

Structure: Polystyrene-hydrogenated
butadiene-polystyrene

5 Number average molecular weight = 250,000

 Number average molecular weight per
polystyrene block = 41,300

 Number average molecular weight of
hydrogenated polybutadiene = 167,500

10 Total content of styrene component = 33%

 1,2-Vinyl content = 33%

 Hydrogenation rate of polybutadiene portion =
98% or more

Conductive material as the component (D):

15 Conductive carbon black (hereinafter referred
to as CCB)

 Trademark: Ketjen black EC-600JD

 Polyamide 66/carbon fibril master batch
(hereinafter referred to as CF-MB)

20 Tradename: Polyamide 66 with Fibril TM

Nanotubes RMB4620-00: carbon fibril content 20%)

Various evaluation tests shown in the
Examples and Comparative Examples were carried out as
follows.

(1) Preparation of test piece:

As test pieces for tensile test and Izod impact test, TYPE 1 test pieces described in ASTM D638 were prepared using an injection molding machine (PS40E manufactured by Nissei Jushi Kogyo K.K.) at a cylinder temperature of 290°C and a mold temperature of 80°C. As a test piece for multi-axial impact test, a flat plate of 100 mm × 100 mm (2 mm thick) was prepared using an injection molding machine (FS80S manufactured by Nissei Jushi Kogyo K.K.) at a cylinder temperature of 300°C and a mold temperature of 80°C.

(2) Measurement in tensile test and Izod impact test:

The tensile test was conducted in accordance with ASTM D638, and the notched Izod impact test was conducted in accordance with ASTM D256.

(3) Measurement in multi-axial impact test:

In the multi-axial impact test, a falling weight impact test was conducted by falling a striker from a height of 128 cm using a falling weight graphic impact tester (manufactured by Toyo Seiki Co., Ltd.) with a holder diameter of 50 φmm, a striker diameter of 1 inch and a striker weight of 6.5 kg, thereby measuring a crack initiation energy.

(4) Measurement of distortion temperature under load (DTUL):

The distortion temperature under load was measured in accordance with ASTM D648 (under loads of

0.45 MPa and 1.82 MPa). The test piece had a thickness of 3 mm.

(5) Measurement of flowability:

Melt flow rate (MFR) was obtained by
5 measuring a flow per 10 minutes in accordance with ASTM
D1238 under the conditions of a temperature of 280°C
and a load of 5 kg.

<Examples 1-3>

The cylinder temperature of a twin screw
10 extruder with one feed opening in the upstream, one
feed opening in the middle of the extruder and one feed
opening in the downstream [ZSK-58MC, manufactured by
WERNER & PFLEIDERER, Germany] was set at 320°C at the
portion from the feed opening in the upstream
15 (hereinafter referred to as Main-F) to the feed opening
in the middle (hereinafter referred to as Side-F1) and
at 280°C at the portion from the Side-F to a die. In
this case, when the total length of the screw was
assumed to be 1.0, the position of the Side-F1 was at
20 about 0.55 and the position of the downstream feed
opening (hereinafter referred to as Side-F2) was at
about 0.75 from the upstream side. Vent ports were
provided at the two positions of about 0.35 and about
0.90, and vacuum suction was carried out.

25 The extruder used above had an L/D of 52 and
a screw revolution speed of 900 rpm, and each feeder
was adjusted so as to give a discharge rate of 540

kg/h.

Polyphenylene ether and a block copolymer were fed from the Main-F and a polyamide was fed from the Side-F in a proportion as shown in Table 1, and 5 were melt-kneaded to obtain pellets. In this case, 0.5 part by weight of maleic anhydride as a compatibilizer was added together with the polyphenylene ether and the block copolymer. The resulting pellets were molded by the above methods, and the various tests were 10 conducted.

The results are shown in Table 2.

The block copolymer in the form of pellets was fed by a feeder different from the feeder used for feeding the polyphenylene ether, and the powdery block 15 copolymer was premixed with polyphenylene ether and the mixture was fed.

Table 1

Items	Unit	Ex. 1	Ex. 2	Ex. 3
PA	Parts by weight	53	53	53
PPE	Parts by weight	36	36	36
C1-2	Parts by weight			3
C1-4	Parts by weight	3	3	
C2-1	Parts by weight		3	3
C2-6	Parts by weight	8		
C2-8	Parts by weight		5	5
Mn _{(a)av}	g/mol	28,000	29,800	27,400
Mn _{(b)av}	g/mol	99,100	96,300	90,700
N _{(c1)/N_(c2)}	--	0.55	0.27	0.41

Table 2

Items	Unit	Ex. 1	Ex. 2	Ex. 3
Izod Impact Strength	J/m	751	809	788
Tensile Elongation	%	83	78	92
Multi Axial Impact Strength	J	48	47	47
DTUL(0.45Mpa)	°C	204	203	204
DTUL(1.82Mpa)	°C	115	115	125

<Examples 4-12>

Example 1 was repeated, except that the compositions were changed to those shown in Table 3, and the various tests were conducted. The results are
5 shown in Table 4. In this case, CCB was fed from the Side-F2.

Table 3

Items	Unit	Ex. 4	Ex. 5	Ex. 6	Ex. 7	Ex. 8	Ex. 9	Ex. 10 (Comp.)	Ex. 11 (Comp.)	Ex. 12 (Comp.)
PA	parts by weight	53	53	53	53	53	53	53	53	53
PPE	parts by weight	38	38	38	38	38	38	38	38	38
CCB	parts by weight	1.5	1.5	1.5	1.5	1.5	1.5	1.5	1.5	1.5
C1-1	parts by weight	2								
C1-3	parts by weight		2	2	2	3	4	6	6	3
C2-4	parts by weight	7			7	6	5	3	3	
C2-5	parts by weight			7						
C2-7	parts by weight		7							
C2-8	parts by weight									6
Mn _{(a)av}	g/mol	13,900	29,600	18,100	16,000	17,900	19,800	23,500	38,600	37,200
Mn _{(b)av}	g/mol	53,500	94,600	63,100	57,900	55,200	52,400	47,000	139,000	125,000
N _{(c1)/N_(c2)}	--	0.44	0.50	0.29	0.26	0.45	0.73	1.81	0.74	1.29

Table 4

Items	Unit	Ex. 4	Ex. 5	Ex. 6	Ex. 7	Ex. 8	Ex. 9	Ex. 10 (Comp.)	Ex. 11 (Comp.)	Ex. 12 (Comp.)
Izod Impact Strength	J/m	204	190	180	196	190	182	104	183	159
Tensile Elongation	%	63	49	58	62	63	60	52	43	46
Multi Axial Impact Strength	J	47	20	40	48	47	40	15	13	10
DTUL(0.45Mpa)	°C	214	210	212	212	210	212	210	211	211
DTUL(1.82MPa)	°C	120	106	110	111	120	125	129	121	123
MFR	g/10 min	32	31	27	27	28	29	25	24	28

<Example 13>

Thirty-eight Parts by weight of polyphenylene ether, 2 parts by weight of C1-3, and 7 parts by weight of C2-4 were fed from the Top-F, 47 parts by weight of a polyamide was fed from the Side-F1, and 7.5 parts by weight of CF-MB was fed from the Side-F2, and they were melt kneaded to obtain pellets. The substantial composition of the pellets in this case corresponded to the composition of Example 7 in which CCB was changed to carbon fibril (CF).

The resulting pellets were molded, and the multi-axial impact strength of the composition was measured to obtain 53J. Furthermore, the tensile elongation was 100% or more.

The composition of the present invention can be markedly improved in impact characteristics corresponding to crash of cars, falling of containers, etc., particularly, tensile elongation and multi-axial impact strength, while retaining the flowability and heat resistance, as compared with conventional techniques.